

() Preliminary Specifications(V) Final Specifications

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Module	13.3"(13.28") WXGA Color TFT-LCD with LED Backlight design			
Model Name	B133EW07 V2 (H/W:0A)			
Note (🗭)	LED Backlight without driving circuit design			

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Note: This Specification is subject to change without notice.	NBBU Marketing Division / AU Optronics corporation



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Record of Revision

Vei	Version and Date Pag		Old description	New Description	Remark
1.0	2010/2/25	All	Final spec		



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



2. General Description

B133EW07 V2 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the WXGA (1280(H) x 800(V)) screen and 262k colors (RGB 6-bits data driver) without LED backlight driving circuit. All input signals are LVDS interface compatible.

B133EW07 V2 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit		Specifi	cations			
Screen Diagonal	[mm]	337.8 ,13.3	W"(13.28)				
Active Area	[mm]	286.08 X178.8					
Pixels H x V		1280x3(RG	iB) x 800				
Pixel Pitch	[mm]	0.2235X0.2	235				
Pixel Format		R.G.B. Verl	tical Stripe				
Display Mode		Normally W	/hite				
White Luminance (Note: ILED is LED current)	[cd/m ²]	330 typ. 300min ILED=23 mA @94% duty cycle					
Luminance Uniformity		50 max. (16	60 points)				
Contrast Ratio		500 typ, 40	0min				
Response Time	[ms]	8 typ / 16 Max					
Nominal Input Voltage VDD	[Volt]	+3.3 typ.					
Power Consumption	[Watt]	tt] 4.36 W @ Black (typical, the logic plus the backlight @94% duty cycle @23mA, 3.3V forward bias voltage)			•		
Weight	[Grams]	300typ., 31	0 max.				
Physical Size	[mm]		Min.	Тур.	Max.		
		Length	-	297.15	-		
		Width - 203.15 -					
		Thickness - 3.6					
Electrical Interface		1 channel LVDS					
Glass Thickness	[mm]	0.5					
Surface Treatment		Glare, Hardness 3H,					



Support Color		262K colors (RGB 6-bit)
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

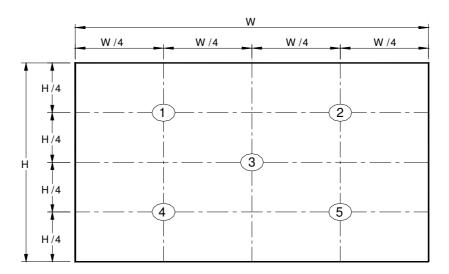
2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

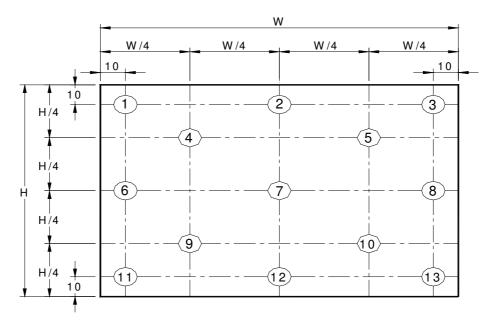
Item		Symbol	Conditio	ns	Min.	Тур.	Max.	Unit	Note	
White Luminance			160 points average		300	330	-	cd/m ²	1, 4, 5.	
		heta R	Horizontal (Right)		65	70	•			
Viewing Aı	agla	heta L	CR = 10 (Left)		65	70	-	degree		
viewing Ai	igie	ф н	Vertical ((Upper)	40	45	•		4, 9	
		φ L	CR = 10 (L	ower)	50	55	-			
Luminan Uniformi		δ _{160P}	160 Poin	ıts	50	-	-		2, 3, 4	
Contrast R	atio	CR			400	500	-		4, 6	
Cross talk		%	Optical				2.0		4, 7	
		Tr	Rising		-	-	•			
Response ⁻	Гime	T _f	Falling			-		msec	4, 8	
		T _{RT}	Rising + Falling		-	16	25			
	Red	Rx			0.620	0.640	0.660			
		Ry			0.315	0.330	0.345			
		Gx			0.290	0.310	0.330			
Color /	Green	Gy			0.590	0.610	0.630			
Chromaticity Coodinates		Вх	CIE 193	:1	0.120	0.150	0.170		4	
	Blue	Ву			0.040	0.060	0.080			
		Wx			0.297	0.313	0.329			
	White	Wy		-	0.313	0.329	0.345			
NTSC	NTSC				-	72	-			



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

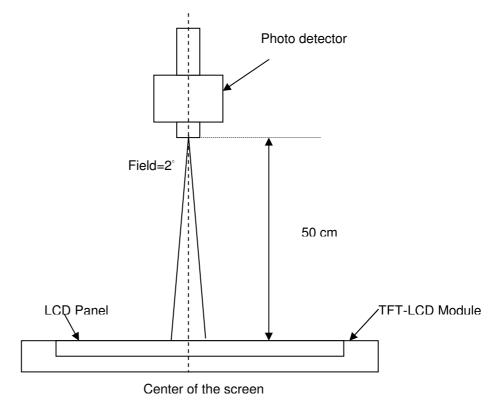
2	=	Maximum Brightness of five points
δ w5		Minimum Brightness of five points
2	_	Maximum Brightness of thirteen points
δ w13	= '	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

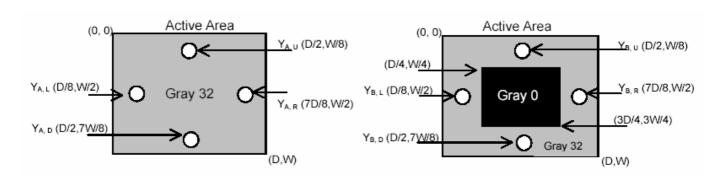
$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

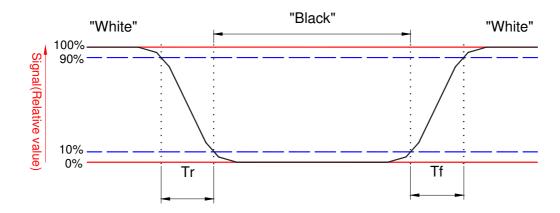
Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

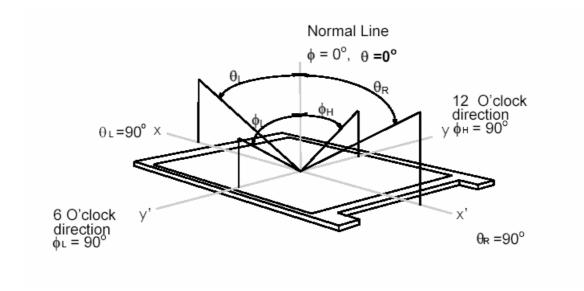




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Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.

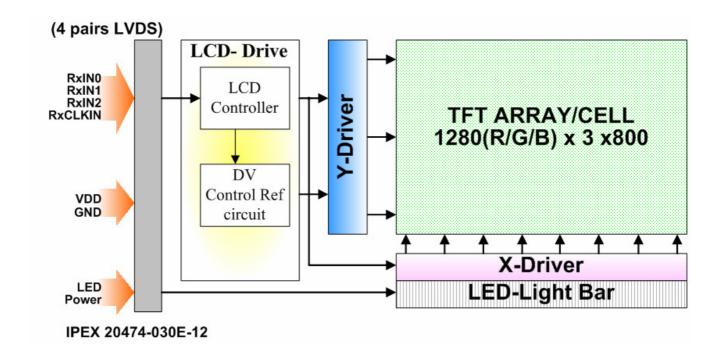




3. Functional Block Diagram

The following diagram

ws the functional block of the 13.3 inches wide Color TFT/LCD 30 Pin (One CH/connector Module)





4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

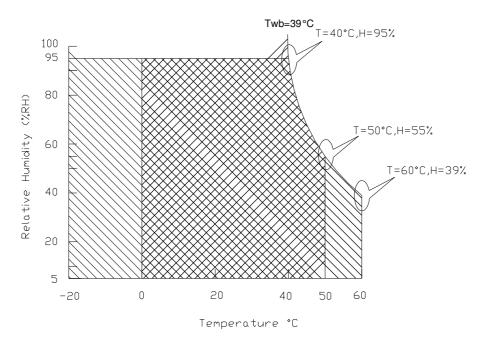
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

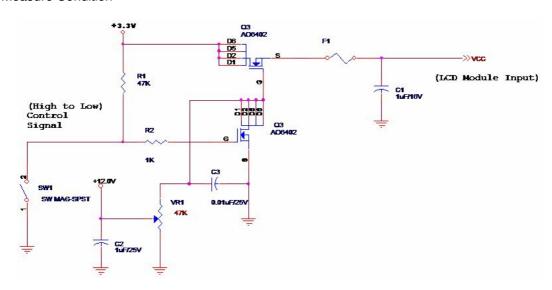
Input power specifications are as follows;

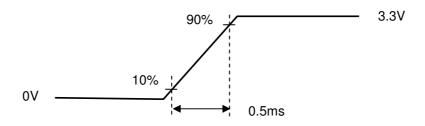
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	0.9	[Watt]	Note 1
IDD	IDD Current	-	220	250	[mA]	Note 1
lRush	Inrush Current	-	700	1500	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (P_{max}=V_{3.3} x I_{black})

Note 2: Measure Condition





Vin rising time



5.1.2 Signal Electrical Characteristics

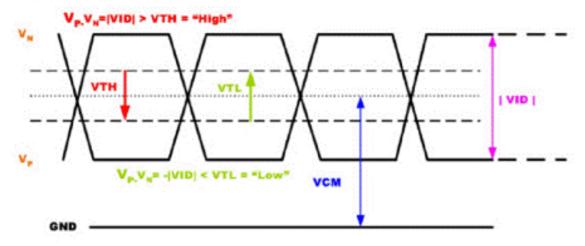
Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{TH}	Differential Input High Threshold (Vcm=+1.2V)		+100	[mV]
V _{TL}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{CM}	Differential Input Common Mode Voltage	0.8	2.0	[V]

Note: LVDS Signal Waveform

Single-end Signal





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5.2 Backlight Unit

Parameter guideline for LED

LED Parameter guideline for LED driving selection (Ref. Remark 1)

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED			3.2	[Watt]	(Ta=25°C)
LED Forward Current	IF		20	30	[mA]	(Ta= 25°C)
LED Power consumption	P _{LED}		4		[Watt]	(Ta=25°C) Note 1
LED Life-Time	N/A	10,000			Hour	(Ta=25°C), Note 2 I _F =20 mA
Output PWM frequency	F _{PWM}	100	200	20K	Hz	
Duty ratio @20kHZ		5		100	%	

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

Note 3: Totally using 54 Led bins



6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1				1280
1st Line	R G B	R G B		R G	B R G B
	1	1	1		
				•	
			·		
				•	
			•	•	
		,		,	
	ı	1	1	1	'
800th Line	R G B	R G B		R G	B R G B



6.2 The input data format

RxCLKIN		
RxIN0	G0 R5 R4 R3 R2	R1 R0
RxIN1	B1 B0 G5 G4 G3	G2 G1 X
RxIN2	DE VS HS B5 B4	B3 B2

Cianal Nama	Description	
Signal Name	Description (MCD)	Dad sixel Data
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	Red-pixel Data	
	·	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	, ,	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and
		DE signals. All pixel data shall be valid at the
		falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface and Pin Assignment

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20474-030E-12 or compatible
Mating Housing/Part Number	IPEX 20472-030E-12 or compatible

6.3.2 Pin Assignment

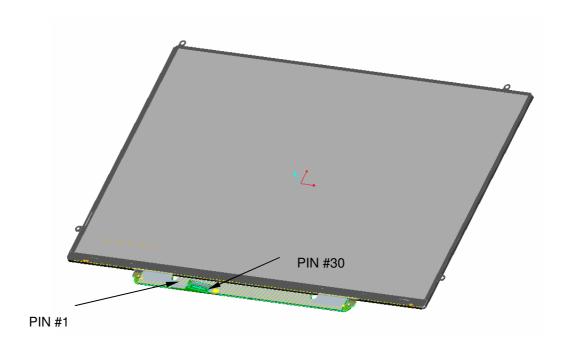
LVDS is a differential signal technology for LCD interface and high speed data transfer device.

Pin	Symbol	Description		
1	GND	Ground		
2	Vcc	Power Supply (+3.3V)		
3	V _{analog}	Power Supply (+3.3V)		
4	V_{EDID}	DDC Power +3.3V		
5	Vsync	Vsync		
6	Clk _{EDID}	DDC Clock		
7	DATA _{EDID}	DDC Data		
8	Rin0-	Differential Data Input		
9	Rin0+	Differential Data Input		
10	GND	Ground		
11	Rin1-	Differential Data Input		
12	Rin1+	Differential Data Input		
13	GND	Ground		
14	Rin2-	Differential Data Input		
15	Rin2+	Differential Data Input		
16	GND	Ground		
17	Clkin-	Differential Clock Input		
18	Clkin+	Differential Clock Input		
19	GND	Ground		
20	NC	NC		
21	Vdc(1 &2)	LED Annold (Positive)		
22	Vdc(3&4)	LED Annold (Positive)		



23	NC	NC
24	Vdc1	LED Cathode (Negative)
25	Vdc2	LED Cathode (Negative)
26	Vdc3	LED Cathode (Negative)
27	Vdc4	LED Cathode (Negative)
28	Vdc5	LED Cathode (Negative)
29	Vdc6	LED Cathode (Negative)
30	NC	NC

Note: Connector Diagram





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6.4.1 Timing Characteristics

Basically, interface timings should match the 1280x800 /60Hz manufacturing guide line timing.

Signal	Parameter	Symbol	Min	Тур	Max	Unit	ote
$\mathrm{D}_{\mathrm{CLK}}$	Clock Period	T_{C}		13.79		ns	1
	Clock Frequency	f_{C}		72.50		MHz	1/T _C
	Duty Ratio (% High)	K_{dr}	40	50	60	%	T_{Ch}/T_{C}
	Rise Time	$T_{R \; CLK}$	-	4.42	-	ns	
	Fall Time	T_{FCLK}	-	4.42	-	ns	
DE	DE Setup Time	T_{se}	4	-	-	ns	
(Data Enable	Data Setup Time	T_{sd}	4	-	-	ns	
Only)	Data Hold Time	T_{hd}	2	-	-	ns	
(DTMG)	Horizontal Period	T_{H}		1440		$T_{\rm C}$	2
Data	Horizontal Blank Period	T_{ha}		160		$T_{\rm C}$	
	Vertical Period	T_{V}		823		T_{H}	f _V =59.94 Hz, 3
	Vertical Blank Period	T_{wvb}		23		$T_{ m H}$	
H_{sync}	H _{sync} Back Porch	H_{bp}		80		$T_{\rm C}$	
	H _{sync} Pulse Width	T_{WH}		32		$T_{\rm C}$	
	H _{sync} Front Porch	H_{fp}		48		$T_{\rm C}$	
	Horizontal Active Period	T_{HD}	1280	1280	1280	T_{C}	Display Period
$V_{ m sync}$	V _{sync} Back Porch	V_{bp}		14		$\mathrm{T_{H}}$	
	V _{sync} Pulse Width	T_{WV}		6		T_{H}	
	V _{sync} Front Porch	V_{fp}		3		T_{H}	
	Vertical Active Period	$T_{ m VD}$	800	800	800	$\mathrm{T_{H}}$	Display Period

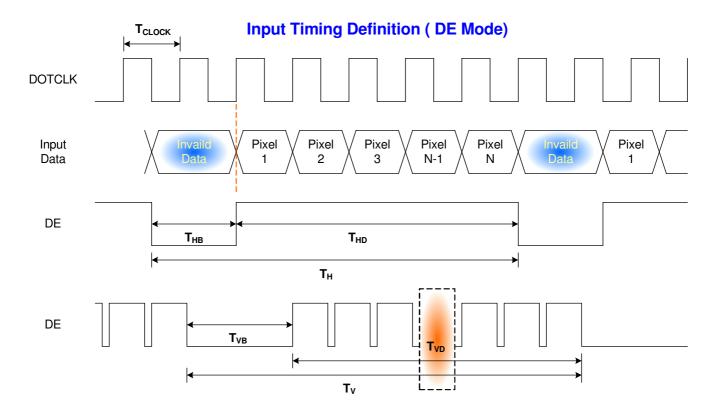
Note: (1) When the WXGA+ controller sets DE Mode, and H_{sync} and V_{sync} are required. The duration of DE (DTMG) signal must be longer than 1 clock period (T_C) at every horizontal sync period;

- (2) Horizontal Period = One Line Scanning Time;
- (3) The vertical period T_V is related to the frame frequency f_V , *i.e.*, 60 Hz.



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6.4.2 Timing diagram

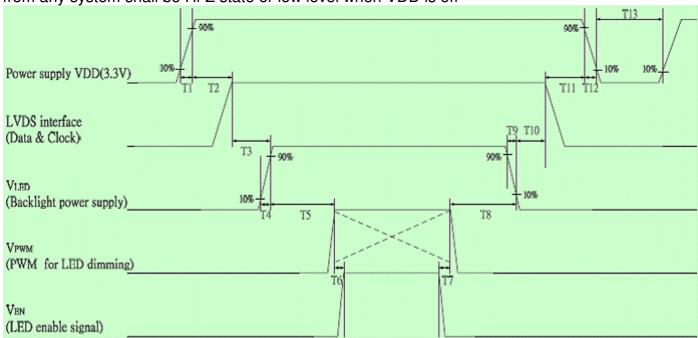




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6.4.3 Power ON/OFF Sequence

VDD power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Power Sequence Timing

		Value		
Parameter	Min.	Тур.	Max.	Units
T1	0.5	-	10	
T2	0	-	50	
Т3	200	-	-	
T4	0.5	-	10	
Т5	10	-	-	
Т6	10	-	-	
Т7	0	-	-	ms
Т8	10	-	-	
Т9	0	-	10	
T10	200	-	-	
T11	0.5	-	50	
T12	0	-	10	
T13	400		-	



7. Vibration and Shock Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 3 G

Frequency: 5 - 150Hz Random

30 Minutes each Axis (X, Y, Z) Sweep:

7.2 Shock Test Spec:

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 50℃, 90%RH, 240h	
High Temperature Operation	Ta= 50℃, 500h	
Low Temperature Operation	Ta= 0℃, 500h	
High Temperature Storage	Ta= 65℃, 500h	
Low Temperature Storage	Ta= -25℃, 500h	
Thermal Shock Test	Ta=-25℃to 65℃, 5min transfer time, 100 cycles	
ESD	Contact : ±8 KV	Note 1
	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

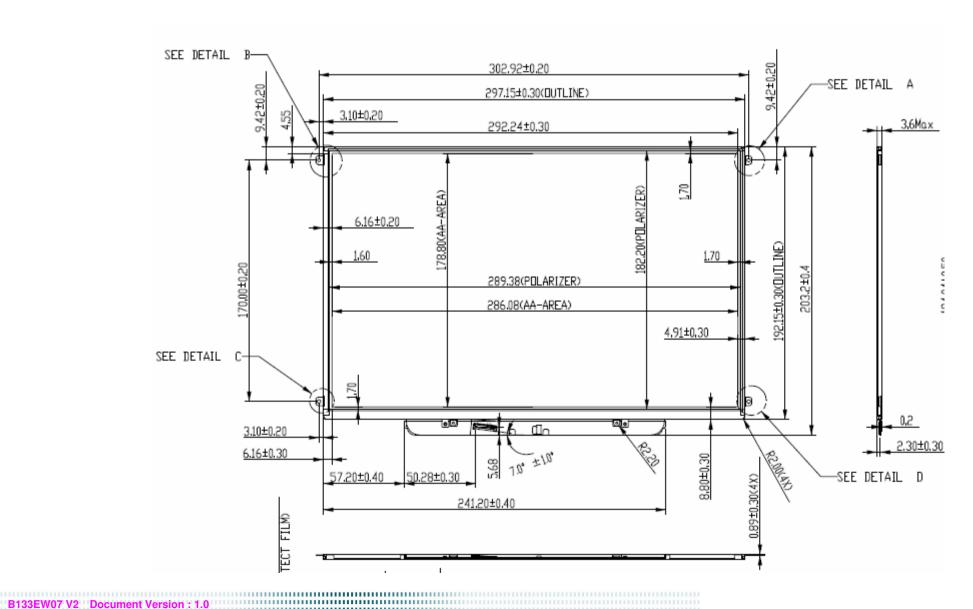
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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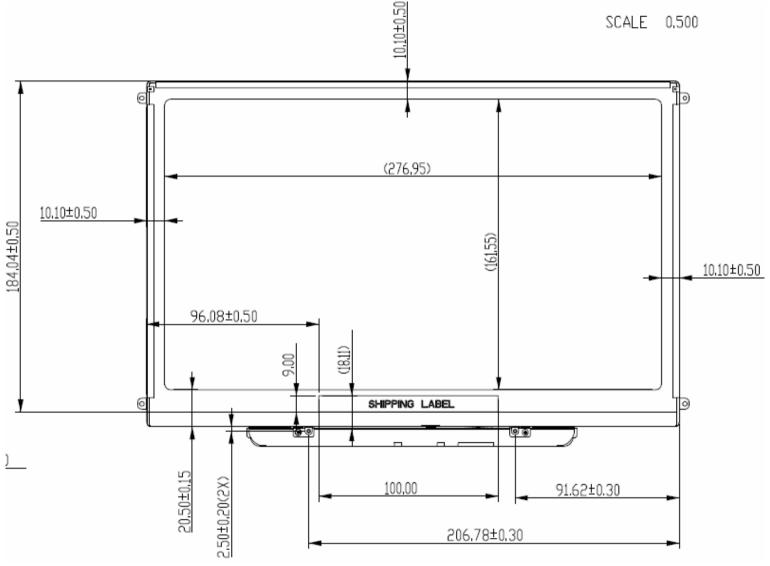
8. Mechanical Characteristics

8.1 LCM Outline Dimension





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Note: Prevention IC damage, IC positions not allowed any overlap over these areas.



9. Shipping and Package

9.1 Shipping Label Format

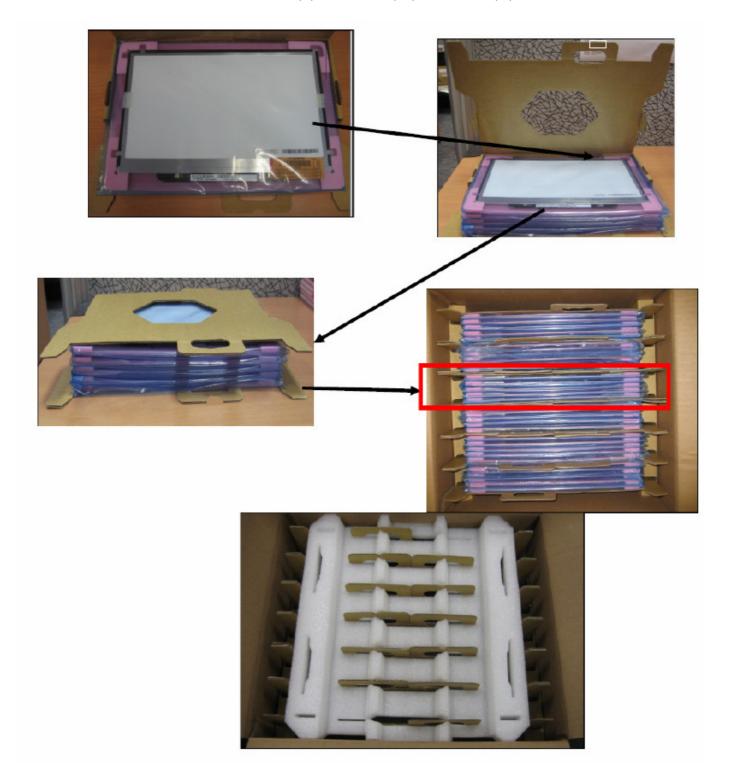
AU Optronics B133EW07 V.2

07/11 HW0A F/W0 MADE IN CHINA (801) HF



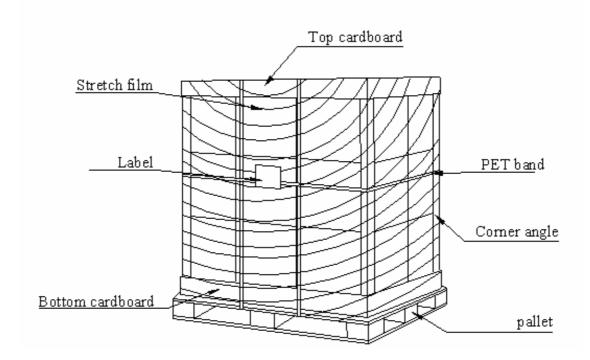
9.2 Carton package

The outside dimension of carton is 435 (L)mm x 377 (W)mm x 335 (H)mm





9.3 Shipping package of palletizing sequence





10. Appendix: EDID description

2	B133EW07	Value	Value	Note
Header	HEX	BIN	DEC	
	00	00000000	0	
	FF	11111111	255	
	FF	11111111	255	
	FF	11111111	255	
	FF	11111111	255	
	FF	11111111	255	
	FF	11111111	255	
	00	00000000	0	
EI SA Manu f. Code LSB	06	00000110	6	APP9CCB
Compressed ASCII	10	00010000	16	0 00001(A) 10000(P) 10000(P)
Product Code	СВ	11001011	203	9CCB (apple assigned code)
hex, LSB first	9C	10011100	156	
32-bit ser #	01	0000001	1	unused
	01	0000001	1	
	01	0000001	1	
	01	0000001	1	
Week of manufacture	01	0000001	1	Week 1
Year of manufacture	13	00010011	19	19(2009-1990=19)
EDID Structure Ver.	01	0000001	1	
EDID revision #	03	00000011	3	
Video input definition	80	1000000	128	Digital Input
Max H Image size	1D	00011101	29	28.6cm
Max V image size	12	00010010	18	17.9cm
Display Gamma	78	01111000	120	Gamma 2.2
Feature support	0A	00001010	10	no DPMS,Active off,RGB color
Red/green low bits	C5	11000101	197	
Blue/white low bits	95	10010101	149	
Red x/ high bits	А3	10100011	163	Rx=0.640
Red y	57	01010111	87	Ry=0.340
Green x	4F	01001111	79	Gx=0.310
Green y	9C	10011100	156	Gy=0.610
Blu e x	26	00100110	38	Bx=0.150
Blue y	0F	00001111	15	By=0.060
White x	50	01010000	80	Wx=0.313
White y	54	01010100	84	Wy=0.329
Established timing 1	00	00000000	0	unused
Established timing 2	00	00000000	0	
Manufacturer's Timing	00	00000000	0	
Standard timing #1	01	0000001	1	unused
	01	0000001	1	



Standard timing #2	01	0000001	1	
	01	0000001	1	
Standard timing #3	01	0000001	1	
	01	0000001	1	
Standard timing #4	01	0000001	1	
-	01	0000001	1	
Standard timing #5	01	0000001	1	
	01	0000001	1	
Standard timing #6	01	0000001	1	
	01	0000001	1	
Standard timing #7	01	0000001	1	
	01	0000001	1	
Standard timing #8	01	0000001	1	
	01	0000001	1	
Pixel Clock/10,000 (LSB)	52	01010010	82	Timing Descriptor #1
Pixel Clock/10,000 (MSB)	1C	00011100	28	1280x800 @60_mode:pixel clock=72.5MHz
Horiz. Active pixels(Lower 8 bits)	00	00000000	0	Horiz active=1280 pixels
Horiz.Blanking (Lower 8 bits)	8F	10001111	143	Horiz blanking=143pixels
Horiz. Active pixels:Horiz. Blanking (Upper4:4 bits)	50	01010000	80	
	20	00100000	32	Vertcal active=800 lines
	2E	00101110	46	Vertical blanking=46 lines
Vert. Active pixels:Vert. Blanking (Upper4:4 bits)	30	00110000	48	
	30	00110000	48	Horiz sync. Offset=48 pixels
	20	00100000	32	Horiz sync. Pulse Width=32 pixels
Vert. Sync. Offset=xx lines, Sync Width=xx lines	36	00110110	54	Verti sync. Offset=3 lines,Sync Width=6 lines
Horz. Ver. Sync/Width (upper 2				
bits)	00	00000000	0	
	00 1E	00000000 00011110	0 30	Hori image size= 286 mm
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits)				Hori image size= 286 mm Verti image size = 179mm
bits) Hori. Image size (Lower 8 bits)	1E	00011110	30	
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size	1E B3	00011110	30 179	
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size	1E B3 10	00011110 10110011 00010000	30 179 16	Verti image size = 179mm
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size	1E B3 10 00	00011110 10110011 00010000 00000000	30 179 16 0	Verti image size = 179mm Horizontal Border = 0
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size	1E B3 10 00	00011110 10110011 00010000 00000000 000000	30 179 16 0	Verti image size = 179mm Horizontal Border = 0
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size (Upper 4 bits)	1E B3 10 00 00	00011110 10110011 00010000 00000000 000000	30 179 16 0 0 24	Verti image size = 179mm Horizontal Border = 0
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size (Upper 4 bits) Detailed timing/monitor	1E B3 10 00 00 18	00011110 10110011 00010000 00000000 000000	30 179 16 0 0 24	Verti image size = 179mm Horizontal Border = 0
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size (Upper 4 bits) Detailed timing/monitor	1E B3 10 00 00 18 00 00	00011110 10110011 00010000 00000000 000000	30 179 16 0 0 24 0	Verti image size = 179mm Horizontal Border = 0
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size (Upper 4 bits) Detailed timing/monitor	1E B3 10 00 00 18 00 00 00	00011110 10110011 00010000 00000000 000000	30 179 16 0 0 24 0 0	Verti image size = 179mm Horizontal Border = 0 Vertical Border = 0
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size (Upper 4 bits) Detailed timing/monitor descriptor #2	1E B3 10 00 00 18 00 00 00 00 00 01	00011110 10110011 00010000 00000000 000000	30 179 16 0 0 24 0 0	Verti image size = 179mm Horizontal Border = 0 Vertical Border = 0 For apple
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size (Upper 4 bits) Detailed timing/monitor descriptor #2 Version Apple edid signature Apple edid signature	1E B3 10 00 00 18 00 00 00 01 00	00011110 10110011 00010000 00000000 000000	30 179 16 0 0 24 0 0 0	Verti image size = 179mm Horizontal Border = 0 Vertical Border = 0 For apple For apple
bits) Hori. Image size (Lower 8 bits) Vert. Image size (Lower 8 bits) Hori. Image size : Vert. Image size (Upper 4 bits) Detailed timing/monitor descriptor #2 Version Apple edid signature	1E B3 10 00 00 18 00 00 00 00 00 00 00 00 00	00011110 10110011 00010000 00000000 000000	30 179 16 0 0 24 0 0 0 1	Verti image size = 179mm Horizontal Border = 0 Vertical Border = 0 For apple For apple For apple



Panel features (No inverter)	00	00000000	0	For apple
	00	00000000	0	
	00	00000000	0	
	00	00000000	0	
	00	00000000	0	
	00	00000000	0	
	00	00000000	0	
	0A	00001010	10	
	20	00100000	32	
Detailed timing/monitor	00	00000000	0	ASCII Data String:B133EW07 V
descriptor #3	00	00000000	0	
	00	00000000	0	
	FE	11111110	254	
	00	00000000	0	
	42	01000010	66	В
	31	00110001	49	1
	33	00110011	51	3
	33	00110011	51	3
	45	01000101	69	E
	57	01010111	87	W
	30	00110000	48	0
	37	00110111	55	7
	20	00100000	32	
	56	01010110	86	V
	32	00110010	50	2
	0A	00001010	10	
	20	00100000	32	
Detailed timing/monitor	00	00000000	0	Monitor Name: Color LCD
descriptor #4	00	00000000	0	
	00	00000000	0	
	FE	11111110	254	
	00	00000000	0	
	43	01000011	67	С
	6F	01101111	111	0
	6C	01101100	108	l
	6F	01101111	111	0
	72	01110010	114	r
	20	00100000	32	
	4C	01001100	76	L
	43	01000011	67	С
	44	01000100	68	D
	0A	00001010	10	
	20	00100000	32	
	20	00100000	32	



	20	00100000	32	
Extension Flag	00	0000000	0	
Checksum	63	01100011	99	
		SUM	6400	